

News Release

Unisem Reports Revenue of RM329.6 million (approx. US\$81.4 million) and Net Profit of RM40.6 million (approx. US\$10.0 million) for 3rd Quarter 2015

Kuala Lumpur, 29 Oct 2015 – Unisem (M) Berhad today announced results for the third quarter ended 30 September 2015 (3Q15).

Unisem recorded a consolidated revenue of RM329.6 million (approx. US\$81.4 million) for 3Q15, which represents increase of 10.3 percent and 20.6 percent from the preceding quarter (**2Q15**) and the same quarter a year ago (**3Q14**) respectively. The Group recorded a consolidated net profit of RM40.6 million (approx. US\$10.0 million) compared to net profit of RM31.6 million (approx. US\$8.7 million) in 2Q15 and net profit of RM27.1 million (approx. US\$8.5 million) in 3Q14.

For the nine months period ended 30 September 2015 (**9m15**), the Group recorded revenue of RM908.5 million (approx. US\$241.6 million), a 20.7 percent increase from RM752.9 million (approx. US\$232.5 million) achieved for the 9-month period a year ago (**9m14**). For 9m15, the Group recorded a net profit of RM96.1 million (approx. US\$25.6 million) compared to RM46.5 million (approx. US\$14.4 million) recorded in 9m14.

The increase in revenue was mainly attributable to consistent demand for the products and services of the Group and an appreciation in the US\$/RM and US\$/RMB exchange rates, as compared to the rates that prevailed in the corresponding quarter/period a year ago. The improvement in net profits was primarily attributable to increased revenue and better contribution from our wafer bumping and advanced package operations and lower interest expense.

Group earnings before interest, tax, depreciation and amortization (EBITDA) for 3Q15 came in at about RM90.9 million (approx. US\$22.4 million), EBITDA margin was about 27.6 percent, compared to RM78.7 million (approx. US\$21.6 million) in 2Q15. Equipment capacity utilization averaged at about 70 percent for the Group in 3Q15. Group capital expenditure incurred in 3Q15 was about RM47.2 million (approx. US\$11.6 million), principally for purchase of equipment for advanced packaging activities.

Commenting on the outlook of the Group, Mr. John Chia Sin Tet, the group managing director said, "We expect the performance of the Group to remain satisfactory till the end of the financial year."

About Unisem

Unisem is a global provider of semiconductor assembly and test (OSAT) services for many of the world's most successful electronics companies. We offer an integrated suite of packaging and test services such as wafer bumping, wafer probing, wafer grinding; a wide range of leadframe and substrate IC packaging; wafer level CSP; and RF, analog, digital, and mixed signal test. Our turnkey services include design, assembly, test, failure analysis, and electrical, mechanical, and thermal characterization and modeling. Unisem is an established MEMS OSAT with several years of experience in volume consumer and automotive production, in addition to a broad package portfolio covering multiple applications. The company has factory locations in Ipoh, Malaysia; Chengdu, People's Republic of China; and Batam, Indonesia. Unisem is headquartered in Kuala Lumpur, Malaysia.

For additional information on Unisem, please visit: www.unisemgroup.com. Follow Unisem on Twitter and on Linkedin.

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